S/N.09/893,036

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Ajit V. Sath

Ajit V. Sathe Examiner: Quang D. Vu

Serial No.:

09/893,036 June 27, 2001

Group Art Unit: 2811 Docket: 884.469US1

Filed: Title:

FLEXIBLE TAPE ELECTRONICS PACKAGING (as amended)

AMENDMENT AND RESPONSE UNDER 37 CFR § 1.111

Commissioner for Patents Washington, D.C. 20231

Applicant has reviewed the Office Action mailed on July 5, 2002. Please amend the aboveidentified patent application as follows.

IN THE TITLE

Please amend the title as follows: FLEXIBLE TAPE ELECTRONICS PACKAGING [AND METHODS OF MANUFACTURE]

IN THE SPECIFICATION

Please make the paragraph substitutions indicated in the appendix entitled "Clean Version of Amended Specification Paragraphs". The specific changes incorporated in the substitute paragraphs are shown in the following marked-up versions of the original paragraphs.

The subtitle beginning on page 1, line 5 is amended as follows:

<u>Technical Field [of the Invention]</u>

The paragraph beginning on page 1, line 7 is amended as follows:

Embodiments of the [The] present invention relate [relates] generally to electronics packaging[.] and, more particularly [More particularly, the present invention relates] to an electronic package that includes an integrated circuit packaged on a flexible tape substrate, and to manufacturing methods related thereto.

The subtitle beginning on page 1, line 12 is amended as follows:

Background Information [of the Invention]

10/24/02 Mollo